An Innovative Power Module with Power-System-In-Inductor Structure

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Abstract—This paper presents an integrated power module with the features of high power density and high efficiency. A multi-functional integrated magnetic component is designed. The component has the roles of both the filter inductor and the case of the whole power module. With the assist of finite element analysis (FEA), design and optimization of the proposed inductor are demonstrated. It has higher inductance value than the inductor used in conventional designs. It has bigger coil winding and larger surface area, leading to lower DCR and better thermal performances than plastic packaging. Benefiting from these advantages, the power module constructed based on the inductor can achieve higher efficiency and lower temperature than those based on traditional plastic packaging solutions. Design of the inductor is demonstrated through the combination of analytical and simulation methods. An inductor prototype is built and used in an integrated power module to do experimental tests. Loss breakdown of the power module is executed to show the loss of the magnetic component. The proposed power module shows better performances than the plastic packaging solution.

Keywords—power-system-in-inductor packaging; magnetic performance; inductor design; thermal;

I. INTRODUCTION

Power modules have been widely used in telecom equipment, computer servers, and consumer electronics to provide an integrated solution of power management. In a small package, the power modules should integrate all the functions of their counterparts designed with discrete components so that the system design engineers do not need to spend too much time on the power supply solution, saving time for products development. Besides, integrated power module has better performance than the solution of discrete components in terms of reliability and space saving. Non-isolated step-down power modules are the most popular power modules used in today’s industry. They are composed of an integrated buck regulator (or controller with two Mosfets), an inductor, some input and output capacitors, and some auxiliary components.

Figure 1 shows the schematic of a step-down power module. There are quite a few literatures discussing about the package of high density power modules [1-15]. Embedding magnetics and capacitors in the printed circuit boards is demonstrated in [1], however, core loss of the embedded magnetic material is significant. Low temperature co-fired ceramic (LTCC) technology becomes very popular recently in research and can achieve very high power density [2-4, 8-15]. Micro-inductor and micro-transformer based on thin film technology is another key technology used for power modules [5-7]. The disadvantage of this technology is that it has higher Direct Current Resistance (DCR) and causes more loss than conventional inductors. In industry, there are two typical packaging solutions for making the power modules. One is based on PCB substrate. The regulator die, chip inductor and other parts are soldered or wire-bonded on the substrate, and the whole substrate is packaged using injection molding. Manufacturers, such as Linear uses this technology. The other one is based on lead frame. In this way, all the components are connected to the lead frame through wire-bonding, and the whole module is then packaged with injection molding. TI, Micrel, and Intersil use this technology to package their modules. No matter which technology is employed to package the module, the chip inductor is a necessary part in a power module. And to leave some space for plastic material, the chip inductor should be smaller than the mold. It generally takes up about 1/4-1/3 of the whole volume of the module. This paper proposes a new packaging technology called power-system-in-inductor (PSI²). A customized magnetic component is designed, acting as both the case of the whole power module and the filter inductor of the converter. Section II of the paper presents the structure of the power module; Section III will demonstrate design of the customized inductor based on the combination of analytical and simulation methods. Section IV will build a prototype and do comparison experiments with plastic packaging solution. Section V concludes the paper.

Figure 1. Schematic of a step-down power module.
II. **PRINCIPLE OF STRUCTURE**

This section will introduce the structure of the proposed power module. A structure based on traditional packaging technology will also be introduced with the purpose of comparison. Power modules in the market are generally packaged with plastic material by injection molding process. Figure 2 shows the structure of the traditional plastic packaging power module. It has a regulator (in the monolithic version) or several active devices (including a controller and two discrete Mosfets in the multiple chips version), an inductor, and some auxiliary components mounted on the substrate together, then the whole substrate is packaged with plastic material. Figure 3 shows the structure of the proposed power module. The proposed structure has a regulator and some auxiliary components, and an inductor mounted on the PCB board. In contrast to conventional plastic packaged power modules, the inductor also acts as a package case of the whole converter. The magnetic core has a cavity in one half and an embedded coil in the other half. The buck regulator and the auxiliary components are embedded underneath the cavity. Thermally conductive glue is used to attach the top of the regulator to the ceiling of the cavity with the purpose of transferring heat from the regulator to the magnetic core. The embedded coil forms an inductor together with the magnetic core. Therefore, the magnetic core has functions of both power module package and filter inductor in the converter. Benefiting from this package technology, the proposed converter has two advantages over the power modules based on conventional plastic package technology. Firstly, without the necessity of leaving enough room for plastic packaging, the inductor size could be as big as the package size, which means both the winding and magnetic core will be bigger than those of the inductors used in plastic packing. Compared with a conventional plastic packaged power module with a small metal composite inductor inside, the proposed magnetic packaged power module has lower DCR, higher inductance value since the volume of the inductor is larger. Secondly, in the power module, the heat sources are the semiconductor devices and the inductor. In a plastic packaging power module, the heat sources are packaged by the plastic surface (generally 1mm thick), which increases the thermal resistance from the heat sources to ambient. Moreover, the proposed power module has the package composed of magnetic material with higher thermal conductivity than plastic material. It means the magnetic core has better thermal co-efficient and thus lower temperature, which will in turn improve the performance of the whole power module.

III. **INDUCTOR DESIGN AND ANALYSIS**

There are quite a few literature [9-10, 13-18] discussing about the model of inductance calculation and design. Most of them are for inductors on the semiconductor or PCB, which are not suitable for inductor design in this paper. Since the magnetic core has a customized shape, and there’s no existing models for calculating the inductance value, finite element analysis (FEA) is used to simulate the inductance value accurately and design the power module. Benefiting from the proposed structure, the proposed inductor has the same width as the module itself. Therefore, the proposed inductor size is 9mm×9mm×2.8mm. However, the metal powder composite inductor designed for the plastic packaging has to be smaller.
than the module to leave enough room for plastic packaging. Generally, the thickness of the plastic layer is around 1mm for thick power modules. Thus the maximum inductor size is 6mm×6mm×1.8mm by considering the extended soldering points on the inductor leads. This Section analyzes the relationship between the inductance $L$, coil radius $R$, coil width $w$, and wire thickness $t$ based on 15mm×9mm×2.8mm package size chosen for prototype demonstration. After a rough calculation to obtain the number of turns, a 3D FEA simulation is used to optimize the inductance and resistance by sweeping parameters above, based on which further analysis and optimization are executed.

Before the simulation, a rough calculation is executed to obtain the possible number of turns based on the initial winding dimension. Figure 4 shows the top view of the winding embedded in the magnetic core. $A_e$ and $A_s$ show the areas of magnetic materials through which the flux lines go. To guarantee the mechanical stress of the iron powder at the inductor terminal (the coil has to be bended), the iron powder thickness from the winding coil to the edge of the magnetic core should be large enough, which might results in $A_e$ being larger than $A_s$. However, they are assumed equal to simplify the design process of the magnetic path when calculating the number of turns. The inductance value calculating equation is expressed in

$$L = \mu_0 \mu_n N^2 A_e \frac{1}{l}$$  \hspace{1cm} (1)

Where $A_e$ is the effective area for flux density; $l$ is the length of magnetic path; $N$ is the number of turns, $\mu_n$ is the relative permeability of the magnetic material. Both $A_e$ and $l$ highly depend on the radius $R$, width $w$ and thickness $t$ of the coil. The effective area $A_e$ can be calculated by (2)

$$A_e = \pi \cdot r^2$$  \hspace{1cm} (2)

The estimated magnetic path length can be calculated through (3)

$$l = 2h + 2w + r$$  \hspace{1cm} (3)

Where $h$ is the total thickness of the winding, and it can be expressed by the height of the inductor $H$ and thickness of magnetic material above or below the winding $e$ in (4)

$$h = H - 2e$$  \hspace{1cm} (4)

Substitute (2), (3) and (4) in (1), yielding (5)

$$N = \sqrt{\frac{L(2(H-2e) + 2w + r)}{2\mu_0 \mu_n \pi^2}}$$  \hspace{1cm} (5)

In this design, the total height of the inductor $H$ is 2.4mm; thickness of magnetic materials above and below the winding $e$ is set to be 0.65 mm in turn number calculation; the relative permeability of the magnetic material $\mu_n$ is 10 and the proposed inductance value is 1μH. Number of turns is calculated by substituting these parameters into (5) and sweeping internal radius $r$ and conductor width $w$. TABLE 1 shows the calculated results. The number of turns increases with the decrease of the internal radius $r$ and increases with the width of the coil $w$. For the proposed inductor in this paper, the number of turns should include a half turn since it has two terminals leading out from two sides. Therefore, the calculated number of turns should be modified to number of turns in a practical design as shown in TABLE 2. Inductance value calculated based on the TABLE 2 is still close to 1μH although there should be some variations. Based on the calculation and modification, the number of turns can be 3.5, 4.5, 5.5, 6.5, 7.5, 8.5, 9.5 and 10.5 depending on the internal radius and coil width. Even with a simulation tool, it is still very time-consuming to simulate every case of turns. Some of the cases can be easily excluded because of their higher DCR. The equation of DCR calculation is shown in (6):

$$R_{DC} = \rho \cdot \frac{2\pi N \cdot (r + \frac{w}{2})}{(H - 2e) - s} \cdot w$$  \hspace{1cm} (6)

Where $N$ is the number of turns listed in TABLE 2; $\mu$ is the resistivity of the copper; $s$ is the thickness of the insulation layer; $[N]$ is the ceiling integral of the calculated turns listed in TABLE 1.

**TABLE 1 Calculated Number of Turns for The Proposed Inductor**

<table>
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<tr>
<th>$w$ (mm)</th>
<th>1.00</th>
<th>1.20</th>
<th>1.40</th>
<th>1.60</th>
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<td>9.0</td>
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<td>9.6</td>
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<td>7.1</td>
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Figure 4. Dimension of the winding.
The proposed inductor does not have constant magnetic cores, can introduce some error in inductance calculation. The maximum inductance value can be higher than 1μH, it is at about r=2.75mm, w=1mm. There are some points, which are not shown in the curves, reaching 1μH point. For example, r=2.85, w=1.1mm, they are very similar to the point r=2.75mm, w=1mm. For 5.5 turn design, there are three combinations. r=1.8mm, w=1mm; r=2mm, w=1.4mm; r=2.25, w=1.8. For 6.5 turn design, there are five candidates. r=1.2mm, w=1mm; r=1.3mm, w=1.4mm; r=1.4mm, w=1.8mm; r=1.45mm, w=2.2mm; r=1.5mm, w=2.6mm. For different groups of parameters, the DCR shown in Figure 6 is different.

Since the design of an inductor is essentially finding the trade off point of the inductance and DCR under the certain volume condition, it is hard to determine through either the inductance value curves or the DCR value curves. A new margin at both sides of terminals. DCR of the inductor has the same trend as inductance. It increases with increase of the radius r and decreases with increases of coil width w. Therefore, the design of such an inductor is essentially choosing the right parameters to reduce DCR while achieving the expected inductance value. For the 3.5 turn design, DCR is very small since it has less number of turns and thicker copper for each turn, but the inductance value is not high enough to meet the requirement of 1μH specification. It can be excluded from the comparison, then only 4.5 turn, 5.5 turn, 6.5 turn are further considered as candidates. For the 4.5 turn design, the maximum inductance value can be higher than 1μH, it is about r=2.75mm, w=1mm. There are some points, which are not shown in the curves, reaching 1μH point. For example, r=2.85, w=1.1mm, they are very similar to the point r=2.75mm, w=1mm. For 5.5 turn design, there are three combinations. r=1.8mm, w=1mm; r=2mm, w=1.4mm; r=2.25, w=1.8. For 6.5 turn design, there are five candidates. r=1.2mm, w=1mm; r=1.3mm, w=1.4mm; r=1.4mm, w=1.8mm; r=1.45mm, w=2.2mm; r=1.5mm, w=2.6mm. For different groups of parameters, the DCR shown in Figure 6 is different.

Since the design of an inductor is essentially finding the trade off point of the inductance and DCR under the certain volume condition, it is hard to determine through either the inductance value curves or the DCR value curves. A new
Parameter $L/R$ is defined in this paper as a new criterial to choose and optimize the design. It should be noted that this parameter is different from the quality factor $\omega L/R$ which also reflects the AC performance of the magnetics. It is manly used to show the low frequency characteristics of an inductor. Figure 7 shows the curves of $L/R$ for number of turns 4.5, 5.5, 6.5. It can be observed that the $L/R$ is higher for $N=5.5$ than the other two number of turns for the same radius and coil and $L/R$ of the selected candidates.

In Table 4, No. 4 ($N=5.5$, $r=2.25\text{mm}$, $w=1.8\text{mm}$) has the lowest DCR and the highest $L/R$. However, the $r+w$ value is 4.05 which is close to half width of the module. In the real practice of manufacture, by considering the mechanical stress of the magnetic material when bending the coil terminals, there should be 3mm margin (1.5mm on both sides), which means $r+w \leq 3\text{mm}$. With this restriction applied to the candidates, three options are left. They are No. 2 ($N=5.5$, $r=1.8\text{mm}$, $w=1\text{mm}$), No. 5 ($N=6.5$, $r=1.2\text{mm}$, $w=1\text{mm}$) and No. 6 ($N=6.5$, $r=1.3\text{mm}$, $w=1.4\text{mm}$). No.2 has the highest $L/R$ value and it can be selected as a final design. Since the $r+w$ value for No. 2 is 2.8mm, $w$ can be further increased by 0.2mm ($r+w$ is not larger than 3mm) which will not lead to significant decrease of the inductance value. And prototypes will be made based on this parameters ($N=5.5$, $r=1.8\text{mm}$, $w=1.2\text{mm}$). A new simulation is executed based on the selected parameters. The inductance value at no load is 1.1μH, it drops to 1.01μH which still satisfies the specification. A field distribution of flux density at 6A current excitation in the designed inductor is shown in Figure 8. The maximum flux density happens around the winding, which is 0.24mT. The saturation flux density of the magnetic materials is about 1T. Therefore, the inductor still has the potential to be used in higher output current application, such as 12V input, 5V/8A output power module.

IV. PROTOTYPE AND EXPERIMENT

In this section, inductor prototype will be made with the parameters obtained in the last section. Figure 9(a) and Figure 9(b) show the top view and bottom view of the inductor. Two leads were extended from the winding and bended at the bottom of the inductor for soldering on the small PCB board.
which is 0.4mm thick. Discrete components, such as regulator and resistors in the power circuit, are soldered on the area of PCB board underneath the cavity of the inductor. Red glue is used at the bottom of the magnetic core where winding is embedded and the ceiling of the cavity where the regulator chip is located to strengthen the adhesive force during the assembling process. Figure 9(c) shows the bottom view of the assembled power module. Before assembling the inductor on the PCB, inductance vs DC bias is measured using a Wayne Kerr 3260B LCR meter. With the purpose of comparison, it is also simulated through FEA simulation. Figure 10 shows the test and simulation results. They correlate with each other very well. Figure 11 shows the resistance versus switching frequency by measurement and simulation. The power module is then soldered on an evaluation board to do loss analysis and performances test. Loss characteristic of the magnetic material is firstly teste to obtain the parameters of Stenmez equations used in FEA simulation and calculate the core loss. Figure 12 shows the power loss the magnetic materials versus flux density with frequency as a parameter. With the simulated core loss, loss breakdown of the power module is executed. Figure 13 shows the loss of the inductor and the switches.

Two comparison experimental tests will be done with the assembled power module to verify its performance. The first one is to show the advantage of the proposed packaging technology over the conventional plastic packing technology by using the same PCB and circuit but different inductors and packaging. The second one is to compare the performances of the proposed power module with the state-of-art plastic packaging power modules in industry.
As described in Section I, one of the advantages of the proposed power module is that it is able to have larger volume of inductor than that in conventional plastic packaging which has to leave enough margin for injecting plastic material during packaging process. For inductors made with the same magnetic material, larger volume means higher inductance value or lower DCR. Figure 14 shows the picture of the selected metal powder composite inductor used for plastic packaged module. The volume of the inductor is 6mm×6mm×2.2mm. It has 0.9μH inductance value and 17mΩ DCR. Figure 15 shows its inductance value versus DC bias. The prototype of the proposed inductor has 1μH inductance value and 11mΩ DCR. The inductor for plastic packaging has much smaller saturation current than the proposed inductor because it has smaller volume and thinner wire. Both inductors are soldered on the same PCB board to test their efficiency performances under the same load conditions. Figure 16 shows the small board with inductor soldered on it. Figure 17 shows the efficiency comparison results. It can be observed that the PCB board with the proposed inductor has about 2% higher efficiency across the whole load range since it has lower DCR and better performances.
The special magnetic component proposed in this paper has functions of both inductor and the packaging. A PSI structured power module is designed to show the benefit of the magnetic component. Compared with plastic packaging solution, the proposed design has larger inductor volume, and thus higher inductance value. Experimental test shows that the designed power module has a 95.2% high peak efficiency and high saturation current.

V. CONCLUSION

The special magnetic component proposed in this paper has functions of both inductor and the packaging. A PSI structured power module is designed to show the benefit of the magnetic component. Compared with plastic packaging solution, the proposed design has larger inductor volume, and thus higher inductance value. Experimental test shows that the designed power module has a 95.2% high peak efficiency and high saturation current.

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